As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

## INTERPROCESSOR COMMUNICATION METHOD AND MULTIPROCESSOR SYSTEM

the	specification of	which is attached hereto unless the following box is checked:	
	was filed on	as United States Application Number or PCT Internation	al Applicatio
	Number	and was amended on (ii	f applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is known by me to be material to patentability as defined in Title 37. Code of Federal Regulations § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least one country other than the United States. listed below and have also identified below any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed:

## PRIOR FOREIGN APPLICATION(S)

NUMBER	COUNTRY	DAY/MONTH/YEAR FILED	PRIORITY CLAIMED
11-348545	Japan	8/December/1999	Yes
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hereby claim the benefit under Title 35, United States Code § 119(e) of any United States provisional application(s) listed below.

H	APPLICATION NO.	FILING DATE
<sup></sup> 뒠		

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is known by me to be material to-patentability as defined in Title 37, Code of Federal Regulations § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application:

APPLICATION SERIAL NO.	FILING DATE	STATUS: PATENTED, PENDING, ABANDONED

I hereby appoint as my attorneys, with full powers of substitution and revocation, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: Stephen A. Bent, Reg. No. 29,768; David A. Blumenthal, Reg. No. 26,257; John J. Feldhaus, Reg. No. 28,822; Donald D. Jeffery, Reg. No. 19,980; Eugene M. Lee, Reg. No. 32,039; Peter G. Mack, Reg. No. 26,001; Brian J. McNamara, Reg. No. 32,789; Sybil Meloy, Reg. No. 22,749; George E. Quillin, Reg. No. 32,792; Colin G. Sandercock, Reg. No. 31,298; Bernhard D. Saxe, Reg. No. 28,665; Charles F. Schill, Reg. No. 27,590; Richard L. Schwaab, Reg. No. 25,479; Arthur Schwartz, Reg. No. 22,115; Harold C. Wegner, Reg. No. 25,258.

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Address all correspondence to FOLEY & LARDNER. Washington Harbout D.C. 20007-8696. Address telephone quinications to <u>David</u>		-	
I hereby declare that all statements made perein of my own knowledge are helieved to be true; and further that these statements were made with the punishable by fine or imprisonment, or both, under Section 1001 of Title 1 may jeopardize the validity of the application or any patent issued thereon.	8 of the United States	rements made on informa ul false statements and the s Code and that such willf	tion and belief and tilke so made and til false statement
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Full Name of First or Sole Inventor	Signature of Firs	t or Sole Inventor	Date
Hideyuki SHIMONISHI	Hideyoki'	Shimoush ;	Dec.1,2000
Residence Address	*	Country of Citizenshi	p
Tokyo, Japan		Japan	
Post Office Address			
	•		
c/o NEC Corporation, 7-1, Shiba 5-chome, Mi	nato-ku, Toky	o, Japan	
Full Name of Second Inventor	I Clause of Con	and Inventor	I Date
Full Name of Second Inventor	Signature of Seco	ond inventor	Date
	i		
Residence Address	<b>.</b>	Country of Citizenshi	D
			•
Section (Street			
Post Office Address			
	-		
Full Name of Third Inventor	Signature of Thir	rd Inventor	Date
The traine of finia inventor	Signature of Time	id myomor	Date
Residence Address		Country of Citizenshi	p
Post Office Address			· · · · · · · · · · · · · · · · · · ·
Fost Office Address			
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E			
Full Name of Fourth Inventor	Signature of Fou	rth Inventor	Date
H- 1	+		
Residence Address	L	Country of Citizenshi	
II VEZITETICE VITIEZZ		I Commity of Chilemani	P (

Full Name of Fifth Inventor	Signature of Fifth Inventor	Date
Residence Address	Country of Cit	izenship
Post Office Address		

Post Office Address